RATING	OPERATING TEMPERATU	DE DANCE									
RATING			-55 °C TO	-55 °C TO 85 °C STORAGE			RE RANGE	-10 °C TO 50 °C (PACKED CONDITIO			OMON)
	VOLTAGE	VE IVAINGE	40 V AC	C / DC	OPER/		R STORAGE		RELATIVE HUMIDITY 90 % MAX (NOT DE)		
	CURRENT				APPL	PLICABLE CABLE		+-	0.3±0.05mm, GOLD	ΡΙ ΔΤΙ	NG
	JOOKKENT			ECIFIC		NIC		'-	0.0±0.03Hilli, GOLD		110
	T-14				7110		DE	211105	TATELITO	Тот	Ι , τ
	RUCTION		TEST METH	100			KE	JUIKE	EMENTS	QT	AT
		I VISUALL	Y AND BY MEASURIN	IG INSTRUM	ENT.	TACCO	RDING TO	DRAW	/ING.	Τ×	Τ×
			NFIRMED VISUALLY.								$\frac{1}{x}$
FLECTE	RIC CHARA	CTERIS	STICS			1				×	1
VOLTAGE I			FOR 1 min.			NO FL	ASHOVER	OR BF	REAKDOWN.	T ×	Τ×
INSULATIO		100 V DC	100 V DC.				500 MΩ MIN.				×
RESISTAN		A C 20 :>					> 84.437			×	
CONTACT	RESISTANCE	AC 20 m					100 mΩ MAX. INCLUDING FPC,FFC BULK RESISTANCE (L=8mm)				×
	NICAL CH				ITUE-	Ta				.1	
VIBRATION		FREQUENCY 10 TO 55 Hz, HALF AMPLITUDE 0.75 mm, — m/s ² FOR 10 CYCLES IN 3 DIRECTIONS.				① NO ELECTRICAL DISCONTINUITY OF 1 μs. ② CONTACT RESISTANCE: 100 mQ MAX.				1 ×	-
sноск			981 m/s ² , DURATION OF PULSE 6 ms AT 3 TIMES IN 3 DIRECTIONS.				③ NO DAMAGE, CRACK AND LOOSENESS OF PARTS.				-
MECHANICAL OPERATION		20 TIMES	20 TIMES INSERTIONS AND EXTRACTIONS.			 CONTACT RESISTANCE: 100 mΩ MAX. NO DAMAGE, CRACK AND LOOSENESS OF PARTS. 			×	-	
FPC RETENTION FORCE		MEASURED BY APPLICABLE FPC. (THICKNESS OF FPC SHALL BE t=0.30mm AT INITIAL CONDITION.)				DIRECTION OF INSERTION : 13N MIN. (note 1)			×	-	
ENVIRC	NMENTAL	CHARA	ACTERISTICS								
CORROSION SALT MIST			EXPOSED AT 35 ± 2 °C , 5 % SALT WATER SPRAY FOR 96 h.			 CONTACT RESISTANCE: 100 mΩ MAX. NO DAMAGE, CRACK AND LOOSENESS OF PARTS. NO EVIDENCE OF CORROSION WHICH AFFECTS TO OPERATION OF CONNECTOR. 				×	_
RAPID CHANGE OF TEMPERATURE		TIME								×	-
DAMP HEA	DAMP HEAT		EXPOSED AT 40±2 °C,				OF PARTS.				† -
(STEADY STATE)		_	RELATIVE HUMIDITY 90 TO 95 %, 96 h.								
DAMP HEAT, CYCLIC		RELATI	EXPOSED AT -10 TO +65 °C, RELATIVE HUMIDITY 90 TO 96 %, 10 CYCLES,TOTAL 240 h.			 CONTACT RESISTANCE: 100 mΩ MAX. INSULATION RESISTANCE: 1 MΩ MIN. (AT HIGH HUMIDITY) INSULATION RESISTANCE: 50 MΩ MIN. (AT DRY) NO DAMAGE, CRACK AND LOOSENESS OF PARTS. 			×	_	
COU	NT C	ESCRIPTION	ON OF REVISIONS		DESIG	SNED			CHECKED	DA	ATE
A											
REMARK				APPROVE CHECKEI				1	11. 06. 07 11. 06. 06		
					DESIGNE		YH. KOTANI	+	06.06		
Unless otherwise specified, refe			fer to JIS C 5402.			DRAWN		_			06.06
				DRAWING NO. ELC4-322394-01							
HS S		PECIFICATION SHEET P			PART	TNO. FH		133MHJ-65S-0. 4SH(10)		10)	
				CODE	E NO. CL580-1325-0-10			Δ	1/2		

SPECIFICATIONS								
ITEM	TEST METHOD		REQUIREMENTS		АТ			
DRY HEAT	EXPOSED AT 85±2 °C, 96 h.		① CONTACT RESISTANCE: $100 \text{ m}\Omega$ MAX.	×	_			
COLD	EXPOSED AT -55±3°C, 96 h.		② NO DAMAGE, CRACK AND LOOSENESS OF PARTS.	×	_			
SURPHUR DIOXIDE [JIS C 0090]	· ·	80	$ \begin{tabular}{lllllllllllllllllllllllllllllllllll$	×				
HYDROGEN SULPHIDE [JIS C 0092]	EXPOSED AT 40±2 °C , RELATIVE HUMIDITY 80±5% , 10 TO 15 PPM FOR 96 h.	③ NO EVIDENCE OF CORROSION WHICH AFFECTS TO OPERATION OF CONNECTOR.	×	_				
SOLDERABILITY	SOLDERED AT SOLDER TEMPERATURE, 235 ±5°C FOR IMMERSION DURATION, 2±0.5 sec.	- 1	A NEW UNIFORM COATING OF SOLDER SHALL COVER A MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.	×	_			
RESISTANCE TO SOLDERING HEAT	1) REFLOW SOLDERING: PEAK TMP. 250 °C MAX. REFLOW TMP. 230 °C MIN FOR 60 sec. 2) SOLDERING IRONS: TMP. 350 ± 10 °C FOR 5±1 sec.		NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINALS.	×	-			

(note1)

THIS PRODUCT HAS FLIP-LOCK CONSTRUCTION. FASTEN FPC ON PCB OR SOMETHING FIXED IF FORCE IN VERTICAL DIRECTION SHALL BE PREDICTED.

Note QT:Q	ualification Test AT:Assurance Test X:Applicable Test	DRAWIN	IG NO.	ELC4-322394-01		
HRS	SPECIFICATION SHEET	PART NO.	FH33MHJ-65S-0.4SH(10)			
	HIROSE ELECTRIC CO., LTD.	CODE NO	CL580	-1325-0-10	Δ	2/2